

Preliminary Data Sheet

AS5410 3D-Hall Encoder absolute linear

1 General Description

The chip can measure magnetic fields components in all three dimensions and converts the magnetic field information into absolute, position information. The AS5410 supports absolute linear position measurement applications.

Only a simple 2-pole magnet is required as the magnetic field source.

Using two 3D-Hall cells allows both absolute as well as differential 3D magnetic field measurement.

The differential measurement makes the AS5410 ideal for use in rough industrial position sensing applications that include not only dust, dirt or moisture but also unwanted magnetic fields.

All the signal conditioning, including compensation of temperature effects, magnet-to-chip gap changes as well as linearization of the output is included in the IC.

The absolute position information of the magnet is directly accessible over a SPI interface and PWM output. A cycle redundancy check (CRC) allows verification of the received data.

The AS5410 is available in a 14-pin TSSOP package and is qualified for an ambient temperature range from -40°C to +105°C.

It operates at a supply voltage of 3.3V +/-10%.

2 Key Features

- up to 14-bit full scale resolution
- SPI and PWM output
- Wide magnetic input range
- 33 linearization points to achieve high precision
- Absolute linear position sensing up to 50 mm stroke
- Suppression of magnetic stray fields
- Low power operation

3 Applications

- Plunger positioning
- Pedal positioning
- Pneumatic and hydraulic cylinder positioning
- Automation with linear positioning stages through cascading of several AS5410's



Figure 1 AS5410 linear position sensing of the magnet



4 Block Diagram

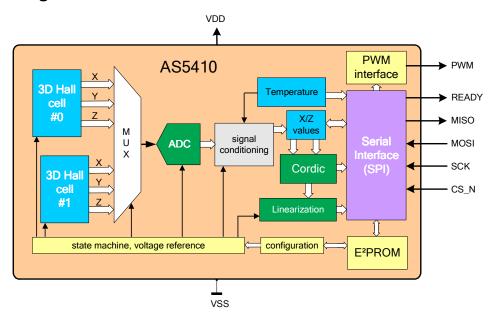


Figure 2: Blockdiagram AS5410

3D Hall cells: The AS5410 contains two 3D Hall cells, spaced 2.5mm apart.

MUX: The Multiplexer selects two magnetic fields as the inputs for the CORDIC. The

selected inputs can either be absolute sensor signals or differential sensor signals

ADC: The Sigma-Delta ADC samples the Hall sensors signals selected by the MUX. The

sampling of the sensors is done sequentially

Signal conditioning: This block includes offset and temperature compensation as well as amplitude

matching

X/Z values: registers containing the input sensor signals of the cordic inputs

Cordic: Coordinate to Rotation Digital Computer: this block converts rectangular coordinates

(sine and cosine signals from the Hall sensors) into polar coordinates (angle/distance

and magnitude)

Linearization: A 33-point linearization of the CORDIC output data is available to accommodate a

variety of different magnet sizes and applications.

Temperature: An on-chip temperature sensor is available. It can be read over the SPI interface. This

sensor is also used for signal conditioning

PWM interface: The linearized measurement data is available over a single pin in the form of a pulse

width modulated (PWM) signal.

SPI interface: A bi-directional SPI interface allows communication with the chip, including reading

measurement data, E2PROM contents or writing configuration data

E²PROM: The on-chip E²PROM contains the configuration data of the chip.

State machine: The state machine controls the automatic sequencing of measurements. Once it is

configured for a certain measurement, the state machine executes all necessary steps

to perform a complete measurement cycle.

Configuration: The configuration is pre-defined in the AS5410.



5 Pinout

5.1 Pin Assignments

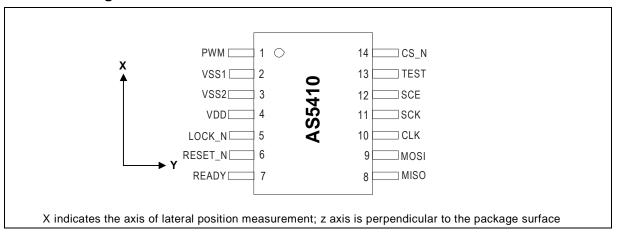


Figure 3: AS5410 pin configuration, TSSOP-14package (top view)

5.2 Sensor Placement

Two pixel cells each with an X-/Y-/Z-Sensor are arranged in a line on the X Axis parallel to the chip edge, 2.5mm distant from each other.

Pixel positions relative to chip centre are:

Pixel 0: -1250 mm Pixel 1: 1250 mm

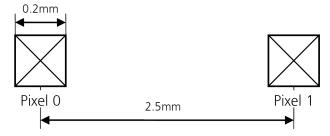


Figure 4: Pixel cell arrangement



5.3 Pin Description

Table 1 Pin description

Pin TSSOP	Symbol	Туре	Description
1	PWM	DO	PWM output. The linearized output data is available on this pin.
2	VSS2	S	Ground (0V) Note: both VSS1 and VSS2 must be connected
3	VSS1	S	Ground (0V) Note: both VSS1 and VSS2 must be connected
4	VDD	S	Positive supply voltage (3.0 3.6V)
5	LOCK_N	DI_ST	Test pin, must be connected to VSS in normal operation
6	RESET_N	DI_ST	Reset input (active low)
7	READY	DO	Measurement ready signal is set high when a measurement cycle is completed and the results in the output registers are valid
8	MISO	DO_T	Master in / Slave out (SPI interface data output)
9	MOSI	DI_ST	Master out / Slave in (SPI interface data input)
10	CLK	DIO	Must be connected to VSS.
11	SCK	DI_ST	SPI interface clock input (max. 16 MHz)
12	SCE	DI_ST	Test pin, must be connected to VSS in normal operation
13	TEST	DI_ST	Test pin, must be connected to VSS in normal operation
14	CS_N	DI_ST	Chip select (active low)

AIO analog input/output
DIO digital output & output
DI_ST digital Schmitt-Trigger input
DO_T digital output /tri-state

S supply pin

Notes:

1) CS_N is active low and activates data transmission. If only a single device is used, CS_N may remain low for several commands, for example while reading the output registers.



5.4 Power modes

The AS5410 can be configured for two power modes:

- Continuous mode
- Single shot mode

5.4.1 Continuous mode

In this mode, the AS5410 is always active. The chip continuously updates the output registers. The completion of a new measurement is signalled with pin READY.

5.4.2 Single shot mode

The AS5410 features an automatic power down mode. After completion of a measurement, the chip automatically suspends to standby. The SPI interface remains active. The control of this mode is possible over register 000Eh (see chapter 8). A high on the Ready output indicates that a measurement is completed. The AS5410 suspends to stand-by state after the Ready output has been set.



Electrical Characteristics

5.5 Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Operating Conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 2 Absolute maximum ratings

Parameter	Min	Max	Unit	Comments
DC supply voltage at pin VDD		5	V	
Input pin voltage	-0.3	VDD +0.3	V	
Input current (latchup immunity)	-100	100	mA	Norm: JEDEC 78
Electrostatic discharge		± 2	kV	Norm: MIL 883 E method 3015
Storage temperature	-55	150	S	Min - 67F; Max +25 7F
Body temperature		000	C	IPC/JEDEC J-Std-020C
Body temperature		260	C	Lead finish 100% Sn "matte tin"
Humidity non-condensing	5	85	%	
Moisture Sensitive Level (MSL)	3	}		Represents a maximum floor time of 168h
EEPROM read/write cycles		100	cycles	

5.6 Operating Conditions

Table 3 Electrical characteristics

Operating conditions: operating temperature = -40 to +105 $^{\circ}$ C, VDD = 3.0-3.6V unless otherwise no ted.

Parameter	Symbol	Min	Тур	Max	Unit	Note
Positive Supply voltage	VDD	3.0	3.3	3.6	V	
Supply current	Isupp		15		mA	Active operation, continuous mode
Operating ambient temperature	Т	-40		+105	C	-40F+185F
Internal oscillator frequency	f _{osc}		8		MHz	
wake up time	twu		2		ms	from cold start
wake up time	twlp			200	μs	from standby; see 5.4.2

Note: 1) the conversion time is based on a single phase measurement of one X, Y- or Z sensor. .

5.7 Performance specifications

The AS5410 can be used in linear applications. Shown in 5.7.1 is an example of an absolute linear displacement sensor for a stroke of 40mm, using Hall elements X0 + X1 (differential) and Z0 + Z1 (differential). The reference magnet used for this application is described in 5.7.2.



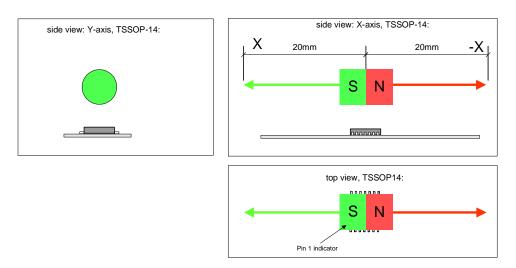


Figure 5: Reference setup for absolute linear displacement measurement

5.7.1 System performance specifications

Operating conditions: magnet placement as specified in Figure , operating temperature = -40 to 105 $^{\circ}$ C, VDD = 3.0-3.6V unless otherwise noted.

Table 4 System Parameters

Parameter	Symb ol	Min	Тур	Max	Unit	Note
Lateral stroke	d _x	-20		20	mm	using the magnet specified in Figure
Signal amplitude, Bx		-60		60	mT	
Signal amplitude, By		-60		60	mT	
Signal amplitude, Bz		-50		50	mT	
Resolution	res			14	Bit	@ 40mm stroke
Sampling rate configuration 0 ¹⁾	Ts		1		ms	normal mode
Sampling rate configuration 1 ¹⁾	Ts		2		ms	slow mode
			0.25		%	@ v=0 m/s,
	acc _{vo}		0.1		mm	tamb = 25℃
	acc _{vo}	-0.5		0.5	%	@ v=0 m/s, 40mm stroke,
Accuracy 2)		-0.2		0.2	mm	$tj = -40 \text{ to } +105^{\circ}\text{C}$
		-2.5		2.5	%	@ v = 1 m/s,
	acc _{v1}	-1		1	mm	40mm stroke tamb = 25℃
	acc _{vma}	-6.5		6.5	%	@ $v = v_{max} = 3 \text{ m/s},$
	х	-2.5		2.5	mm	40mm stroke tamb = 25℃

Note:

¹⁾ configurable in register 000Bh

²⁾ The accuracy data is based on an averaged reading (excluding noise) of the displacement value compared to an absolute reference. Note that with a moving magnet the accuracy is reduced due to the sequential sampling of the Hall sensors and the conversion time of the ADC. The accuracy values shown in this table are valid for room temperature.



5.7.2 Noise performance specifications

Operating conditions: ambient temperature = 25℃, VDD = 3.0-3.6V

Table 5 Input referred noise

Parameter	Symbol	Min	Тур	Max	Unit	Note
Input referred noise 1)	noise _{IN}		38	77	μΤ	3 sigma

Note: 1) AS5410 configuration and setup:

- · absolute measurement of Bx and By
- magnetic fields: Bx = 2.5mT, By = 2.5mT (45°CORDIC angle)
- measurement update rate: 1kHz (factory default setting)

5.8 DC Characteristics for Digital Inputs and Outputs

5.8.1 CMOS Schmitt-Trigger Inputs: LOCK_N, RESET_N, CLK, MOSI, SCK, CS_N, Test, SCE

Operating conditions: operating temperature = -40 to +105℃, VDD = 3.0-3.6V unless otherwise no ted.

Parameter	Symbol	Min	Max	Unit	Note
High lovel input voltage	VIH	1.77	1.87	W	VDD = 3.0V
High level input voltage	VIH	2.07	2.23	V	VDD = 3.6V
Low level input voltage	VIL	1.12	1.27	W	VDD = 3.0V
Low level input voltage	VIL	1.42	1.52	V	VDD = 3.6V
Input current	l _{in}		10	mA	for Vin >VDD 1)

Note: $^{1)}$ Input pin voltages higher than VDD (e.g. 5V TTL levels) must be limited by a series resistor to ensure that the maximum input current (I_{in}) is not exceeded.



5.8.2 CMOS Outputs: READY, MISO, PWM

Operating conditions: operating temperature = -40 to +105°C, VDD = 3.0-3.6V unless otherwise no ted.

Parameter	Symbol	Min	Max	Unit	Note
Output high level	VO _H	2.5	VDD	V	
Output current, source	IO _H		8	mA	
Output low level	VOL	0	0.4	V	
Output current, sink	IO _L		8	mA	

5.8.3 Power On reset

Operating conditions: operating temperature = -40 to +105℃

Parameter	Symbol	Min	Тур	Max	Unit	Note
Reset threshold; VDD level rising	Von	1.24	2.26	2.82	V	
Reset threshold; VDD level falling	V _{off}	1.13		2.67	V	

5.9 On-chip temperature measurement

The AS5410 provides a linear on-chip temperature sensor which is use for automatic compensation of sensitivity and offset drifts for the Hall-In-One sensors.

The measured chip temperature is available in a register (0110h) and can be used for monitoring purposes

Operating conditions: operating temperature = -40 to +105℃

Parameter	Symbol	Min	Тур	Max	Unit	Note
Temperature signal at 25°	D _{temp}		0		LSB	
Resolution	Res _{temp}	185	200	210	LSB/K	

6 Serial Interface (SPI)

The SPI interface provides data transfer between AS5410 and the external microcontroller.

The Interface is conform to the SPI standard.

Note that SPI bus is a de facto standard, rather than one agreed by any international committee.

The minimum number of connections between microcontroller and AS5410 is three:

- 1) MOSI: Master Out Slave In; data transfer from microcontroller to AS5410 (Write)
- 2) MISO: Master In Slave Out; data transfer from AS5410 to microcontroller (Read)
- 3) SCK: Serial clock; Data is written and read with the rising edge of SCK

Optionally, two further connections may be used:

 CS_N: Chip select; this connection is mandatory when multiple AS5410 devices are connected in parallel. In electrically "noisy" environment it is recommended to use the CS_N connection in order to maintain safe data transfer.

For a single unit, this connection is optional as the data transmission is synchronized automatically by the number of SCK cycles. In this case it is recommended to verify the synchronization by CRC (see **Error! Reference source not found.**), Data readback (Figure) or repeated reading and cross-checking of subsequent measurements.

 Ready: this output indicates when data is ready, it is cleared by reading data from address 0100h or 0122h

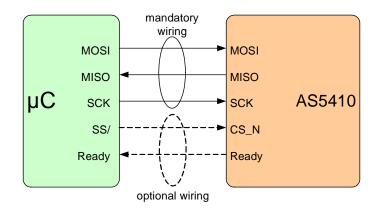


Figure 6: Hardware connection between AS5410 and microcontroller

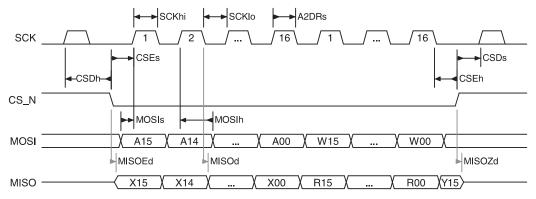


Figure 7: SPI timing diagram

The data bits sent to the chip via MOSI and the data bits received from the chip via MISO are defined as follows (see also Figure):

A15....A00 = 16-bit register address

W15....W00 = 16-bit write data (in write mode)

X15....X00, Y15 = 16-bit read data or previous command (depending on mode) R15...R0

= 16-bit read data in read mode or previous data in write mode

Parameter	Symbol	Min	Тур	Max	Unit	Note
SCK frequency	f _{sck}	0		16	MHz	
SCK pulse width HI	tsckhi	15			ns	
SCK pulse width LO	t _{SCKlo}	15			ns	
SCK setup time before data read	t _{A2DRs}	15			ns	
CS_N enable setup time before SCK	t _{CSEs}	10			ns	
CS_N enable hold time after SCK	t _{CSEh}	10			ns	
CS_N disable setup time before SCK	t _{CSDs}	10			ns	
CS_N disable hold time after SCK	t _{CSDh}	10			ns	
MOSI setup time before SCK	t _{MOSIs}	10			ns	
MOSI hold time after SCK	t _{MOSIh}	10			ns	
MISO delay after SCK	t _{MISOd}			10	ns	
MISO enable delay after CS_N	t _{MISOEd}			10	ns	
MISO high Z delay after CS_N	t _{MISOZd}			10	ns	
Output edge rise time	t _{Or}			3	ns	
Output edge fall time	t _{Of}			3	ns	



7 Data transfer between AS5410 and Microcontroller

Data is transferred to the AS5410 via the MOSI pin (Master Out – Slave In) with the rising edge of SCK. Data is read from the AS5410 from the MISO pin (Master In – Slave Out) with the rising edge of SCK.

The data format consists of data streams with 32 bit in length. The first 16 bits define a 16-bit address and the subsequent 16 bits contain read or write data.

The MSB of the address word A<15> defines the direction of data transfer:

A<15> = 0 READ; data transfer from AS5410 to microcontroller; read measurement data

A<15> = 1 WRITE; data transfer from microcontroller to AS5410; write configuration data

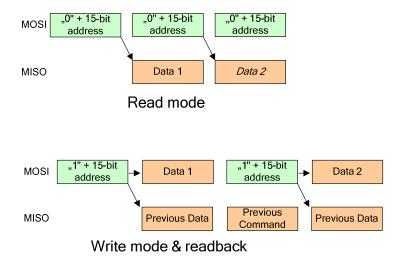


Figure 8: Data transfer between AS5410 and microcontroller

7.1 Read mode

For reading a register, the 16-bit Read address (with A<15>=0) is sent to the MOSI pin. After 16 SCK cycles, data of the specified address is read from the MISO pin (see Figure). At the same time, the new address may be clocked into the MOSI pin.

7.1.1 Continuous measurement

It is possible to continuously read data from the AS5410 even if a new measurement is not yet finished. In this case, the last measurement data will be read. As soon as a new measurement is completed, it will be available at the SPI interface.

7.2 Write mode & readback

For additional safety and detection of communication errors, the actual contents of a register may be read at the same time as new data is written to this register.

In case of a Write command, the 16-bit Write address (with A<15>=1) is sent to the MOSI pin. After 16 SCK cycles, data following the address bits is written to the specified address via MOSI in (see Figure) At the same time, the present data of that register may be read from the MISO pin. Following the 16-bit of data (Data 1 in Figure), a new address may be written to the AS5410. While the new address is written, the address from the previous command is available at the MISO output.

7.3 Checksum

To avoid reading errors, the IC calculates a Checksum at every read cycle from the register content. The Checksum value is built by an XOR operation of the previous Checksum value and the read register content. The CRC is calculated every time a register is read.

By choosing how often the Checksum is read and rechecked by the master it is possible to adjust the communication speed and safety level.

The Checksum value is stored in register 0108h (see chapter 8).



8 Register contents

The following registers can be addressed by the user via the SPI interface. Each register is 16-bit wide. Registers not listed in the table below must not be modified from their factory programmed setting.

Note: "r" are reserved bits, they must not be modified (unless otherwise noted)

8.1 Register 000Bh:

This register controls the sequencer

Register	Access	Bit	Function	Default	Note	
		D15 (MSB)	r	0		
		D14	r	0		
		D13	r	0		
		D12	r	0		
			MgRangExt	0	"Magnet Range Extension" Enable the algorithm for an extended position range. 1 = Magnet Range Extension enabled 0 = Magnet Range Extension disabled	
					"Coordinate System Selection"	
		D10	CoordSel	0	1 = The sign of the Lin Ang (Register 0122h) gets changed if MagDir (Register 000Bh) = 1	
		D9	r	0	0 = Lin Ang (Register 0122h) gets not changed	
		D8	r	0		
		D7	Table Select 0	0	These hits allow the collection of 4 different analysis.	
000Bh:		D6	Table Select 1	0	These bits allow the selection of 4 different operating modes, stored in 4 individual sequencer tables	
Sequencer control	R/W	D5	MagDir	0	This Bit allows to switch the magnet direction MagDir = 0: North pole must point in +x direction (pin 7 to pin1) Default/powerup mode. MagDir = 1: North pole must point in -x direction (pin1 to	
		D4	DiffMd	0	pin7). Preferred orientation to permit use of CoordSel bit Differential mode: 0 = absolute measurement of Hall cells,	
					1 = differential measurement of Hall cells	
		D3	r	0		
		D2	r	0		
					READY Tri-State: 0: The READY pin is always active. It must NOT be connected in parallel	
		D1	RdyHZ	0	1: The READY output may be connected in parallel. It is normally in high Z and only active (high) if the IC is addressed and selected. (Note: a 10k pull down resistor is mandatory at the common READY signal line if RdyHz = 1!)	
		D0 (LSB)	r	0		



	Table 0	Table 1	Table 2	Table 3
	Differential Mode	Differential Mode	Absolut Pixel1	Absolut Pixel1
	1 kHz Sample Rate	0.5 kHz Sample Rate	1 kHz Sample Rate	0.5 kHz Sample Rate
Cordic	Pixelcell0, Bz0 = 0x112h - Pixelcell1, Bz1 = 0x111h	Pixelcell0, Bz0 = 0x112h - Pixelcell1, Bz1 = 0x111h	Pixelcell1, Bz1 = 0x111h	Pixelcell1, Bz1 = 0x111h
Input values	Pixelcell0, Bx0 = 0x114h - Pixelcell1, Bx1 = 0x113h	Pixelcell0, Bx0 = 0x114h - Pixelcell1, Bx1 = 0x113h	Pixelcell1, Bx1 = 0x113h	Pixelcell1, Bx1 = 0x113h
Register	Table Select 1Table Select 0 = 00 (mandatory)	Table Select 1Table Select 0 = 01 (mandatory)	Table Select 1Table Select 0 = 10 (mandatory)	Table Select 1Table Select 0 = 11 (mandatory)
B Settings	DiffMd = 1 (mandatory)	DiffMd = 1 (mandatory)	DiffMd = 0 (mandatory)	DiffMd = 0 (mandatory)
	MgRangExt = 0 or 1 depending on application	MgRangExt = 0 or 1 depending on application	MgRangExt = 0 (mandatory)	MgRangExt = 0 (mandatory)

8.2 Register 000Dh:

Register	Access	Bit	Function	Default	Note
		D15 (MSB)	PWMLimitHi 5	1	
		D14	PWMLimitHi 4	1	
		D13	PWMLimitHi 3	0	PWM Limit High
		D12	PWMLimitHi 2	0	Limits the PWM duty cycle to a maximum value
		D11	PWMLimitHi 1	1	
		D10	PWMLimitHi 0	1	
		D9	PWMLimitLo 5	0	
000Db	DAM	D8	PWMLimitLo 4	0	
000Dh:	R/W	D7	PWMLimitLo 3	1	PWM Limit Low
		D6 PWMLimitLo 2		1	Limits the PWM duty cycle to a minimum value
		D5	PWMLimitLo 1		
		D4	PWMLimitLo 0	1	
		D3	PWMEn	0	PWM Enable, Enables the PWM output
		D2	PWM PreScale 2	0	
		D1	PWM PreScale 1	1	PWM PreScale, Sets PWM frequency and resolution
		D0 (LSB)	PWM PreScale 0	1	

8.3 Register 000Eh:

This register holds the sequencer control bits

Register	Access	Bit	Function	Default	Note
000Eh:		D15 (MSB) - D2	r	0	
Sequencer	R/W	D1	Seq	1	Sequencer Enable
control		D0 (LSB)	SL	0	Single Loop



8.4 Register 000Fh:

This register holds the threshold and hysteresis of the Cordic magnitude value (see register 0120h), at which the "Magnet Lost" flag in register 0107h is set/cleared.

Register	Access	Bit	Function	Default	Note
		D15 (MSB)	r	0	
		D14	r	0	
		D13	r	0	reserved
		D12	r	0	
		D11	r	0	
		H2	Hyst	0	
		H1	Hyst	0	Hysteresis for "magnet lost"
000Fh:	R/W	H0	Hyst	1	
OUUFII.	R/VV	V7	MgnLostLmt	0	
		V6	MgnLostLmt	0	
		V5	MgnLostLmt	0	
		V4	MgnLostLmt	0	Magnet lost threshold value compared to register 0121h
		V3	MgnLostLmt	0	
		V2	MgnLostLmt	0	
		V1	MgnLostLmt	1	
		V0 (LSB)	MgnLostLmt	1	

V7...V0: The minimum allowed Magnitude of Cordic can be selected. The binary number, represented by V7...V0 must be multiplied with 64 to calculate the minnumum allowed Magnitude of Cordic.

Example:

Select V0 and V1.

	decimal							
V7	V6	V5	V4	V3	V2	V1	V0	ueciiiai
0	0	0	0	0	0	1	1	3

The coresdponding dual number to 00000011 is 3 this number multiplied with 64 ist the minimum allowed Magnitude of Crodic.

64 * 3 = 192 = Threshold limit

If the magnitude of cordic turns under 192 the MagLost bit in register 0107h will turn form 0 to 1.

H2...H0: The Hysteresis arround the minimum allowed Magnitude of Cordic can be selected.

The Hysteresis Hystd is calculated by the Formular

Hyst ... Hysteresis value in Register 000Fh

Hystd ...decimal Hysteresis value arround the minimum allowed Magnitude of Cordic

MgnLostLmt ...the Threshold limit as calculated in the example above.

$$Hystd = MgnLostLmt \cdot \frac{1}{2^{Hyst}}$$

Example:

Select H0

k	decimal		
H2	H1	H0	ueciiiai
0	0	1	1

Data Sheet



$$Hystd = MgnLostLmt \cdot \frac{1}{2^{Hyst}} = 192 \cdot \frac{1}{2^1} = 96$$

Now the MagLost bit in register 0107h will turn form 0 to 1 at a Magnitude of Cordic value lower than 192. After the MagLost bit is 0 it turns back to 1 at a value higher than 288, because 192 + 96 = 288.

8.5 Register 0030h:

E2PROM address

Register	Access	Bit	Function	Note
		D15 (MSB)	A15	
		D14	A14	
		D13	A13	
		D12	A12	
		D11	A11	
		D10	A10	To read/write E²PROM contents,
	R/W	D9	A9	the selected E ² PROM address must be specified in this register.
0030h:		D8	A8	The corresponding data is available in register 0031h.
E ² PROM address		D7	A7	For write operations, status bit ED in register 0107h which indicates the completion of a write operation must be verified
address		D6	A6	before starting a new write cycle.
		D5	A5	Writing 16 bits of data requires ~20ms
		D4	A4	
		D3	А3	
		D2	A2	
		D1	A1	
		D0 (LSB)	A0	

8.6 Register 0031h:

E²PROM data

Register	Access	Bit	Function	Note
		D15 (MSB)	D15	
		D14	D14	
		D13	D13	
		D12	D12	
		D11	D11	
		D10	D10	
	R/W	D9	D9	This register holds the E ² PROM contents of the address selecte
0031h:		D8	D8	
E ² PROM data		D7	D7	in register 0030h
data		D6	D6	
		D5	D5	
		D4	D4	
		D3	D3	
		D2	D2	
		D1	D1	
		D0 (LSB)	D0	



8.7 Register 0107h:

Status register; this register holds various status flags

Register	Access	Bit	Function	Note
		D15 (MSB)	RDY	Indicates completion of a new measurement; same function as the "Ready" output pin. 0 = calculation is in progress or chip not ready 1 = measurement completed, new measurement data is stored in register 0110h-0114h and 0120h-0122h
		D14	MagLost	1 = Magnetic field values are too low for position measurement; the threshold level can be selected at Register 000Fh Bit D7D0
		D13	CorrOvfl	Ambiguous angle correction overflow
		D12	NormOvfl	Normalizing scale overflow
		D11	SensOvfl	Overflow during sensitivity correction over temperature
04.075		D10	RngWarn	ADC overflow
0107h:	R	D9	HistWarn	Histogram failure during ADC operation
Status		D8	CalcError	Or wired combination of RngWarn, HistWarn, NormOvfl, SensOvfl
		D7	D7	-reserved-
		D6	D6	-reserved-
		D5	D5	-reserved-
		D4	D4	-reserved-
		D3	D3	-reserved-
		D2	D2	-reserved-
		D1	MagDir	Detected or chosen orientation of Magnet
		D0 (LSB)	ED	E ² PROM write cycle: 0 = E ² PROM write cycle in progress 1= E ² PROM write cycle completed

8.8 Register 0108h:

Cycle Redundancy Check (CRC):

Register	Access	Bit	Function	Note
		D15 (MSB)	CRC15	
		D14	CRC14	
		D13	CRC13	
		D12	CRC12	
		D11	CRC11	
		D10	CRC10	
		D9	CRC9	
0108h:	R	D8	CRC8	Checksum Reading Check
CRC	K	D7	CRC7	Checksum Reduing Check
		D6	CRC6	
		D5	CRC5	
		D4	CRC4	
		D3	CRC3	
		D2	CRC2	
		D1	CRC1	
		D0 (LSB)	CRC0	



8.9 Register 0110h:

On-chip temperature sensor:

Register	Access	Bit	Function	Note
		D15 (MSB)	T15	
		D14	14	
		D13	T13	
		D12	T12	
		D11	T11	
		D10	T10	
		D9	Т9	on-chip temperature sensor
0110h:	R	D8	Т8	
Tempera- ture	K	D7	T7	Temperature[℃] = (Register110h / 200) + 25
taro		D6	T6	
		D5	T5	
		D4	T4	
		D3	Т3	
		D2	T2	
		D1	T1	
		D0 (LSB)	T0	



8.10 Register 0111h:

Magnetic field of Pixel cell 1; Z field sensor cell

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		
		D13		
		D12		
		D11		
		D10	D-4	Magnetic field Bz of Pixel-cell 1
	R	D9		
0111h:		D8		
Magnetic field value		D7	Bz1	
noia vaido		D6		
		D5		
		D4		
		D3		
		D2		
		D1		
		D0 (LSB)		

8.11 Register 0112h:

Magnetic field of Pixel cell 0; Z field sensor cell

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		
		D13		
		D12		
		D11		
		D10	Bz0	
		D9		Magnetic field Bz of Pixel-cell 0
0112h:	R	D8		
Magnetic field value	K	D7	D20	
noid value		D6		
		D5		
		D4		
		D3		
		D2		
		D1		
		D0 (LSB)		



8.12 Register 0113h:

Magnetic field of Pixel cell 1; X field sensor cell

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		
		D13		
		D12		
		D11		
		D10		
		D9	Bx1	Magnetic field Bx of Pixel-cell 1
0113h:	R	D8		
Magnetic field value	K	D7		
neia valae		D6		
		D5		
		D4		
		D3		
		D2		
		D1		
		D0 (LSB)		

8.13 Register 0114h:

Magnetic field of Pixel cell 0; X field sensor cell

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		
		D13		
		D12		
		D11		
		D10		
		D9	Bx0	Magnetic field Bx of Pixel-cell 0
0114h:	_	D8		
Magnetic field value	R	D7		
noia value		D6		
		D5		
		D4		
		D3		
		D2		
		D1		
		D0 (LSB)		

Revision 1.5

19 - 28



8.14 Register 0120h:

Cordic magnitude value; this is representing the strength of the magnetic field, as calculated by the Cordic. These values may for example be used to check the magnet for out-of-range conditions, or to issue a "weak magnetic field" warning when the value gets below a certain threshold

Register	Access	Bit	Function	Note
0120h: Magnitude	R	D15 (MSB) D14 D13 D12 D11 D10 D9 D8 D7 D6 D5 D4 D3 D2 D1 D0 (LSB)	Mag	Magnitude value of cordic

8.15 Register 0121h:

Cordic angle value; this is representing the (non-linearized) angle or direction of the magnetic field, as calculated by the Cordic.

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		
		D13		Ang [9angle value of cordic [9
		D12		0121h angle value of cordic [LSB]
		D11		· · · · · · · · · · · · · · · ·
		D10		MgRangExt = 0:
		D9		
0121h:	R	D8	Ang	$Ang [9] = \frac{360}{65536} * 0121h$
Angle	K	D7	Alig	00000
		D6		
		D5		MgRangExt = 1:
		D4		$Ang [9] = \frac{576}{65536} * 0121h$
		D3		65536
		D2		
		D1		
		D0 (LSB)		



8.16 Register 0122h:

This register holds the final, calculated and linearized position information

Register	Access	Bit	Function	Note
		D15 (MSB)		
		D14		This register holds the linearized 16-bit position information.
		D13		This register holds the inteatized to bit position information.
		D12		LinAng [9linearized 16-bit position information [9
		D11		0121h linearized 16-bit position information [LSB]
		D10		
		D9		MgRangExt = 0:
0122h:	R	D8	LinAng	$LinAng [9] = \frac{360}{65536} * 0122h$
Position	K	D7	LillAlig	$\frac{1}{65536}$
		D6		
		D5		MaDanaEvt 1
		D4		MgRangExt = 1:
		D3		$LinAng [9] = \frac{576}{65536} * 0122h$
		D2		65536
		D1		
		D0 (LSB)		

8.17 EEPROM Linearization Table 005Fh to 007Fh

The data output of the Cordic can be linerarized using the 33 points stored in the EEPORM

Register	Content	Note
005Fh	Angle linearization table, value 16	
0060h	Angle linearization table, value 0	
0061h	Angle linearization table, value 1	
006Fh	Angle linearization table, value 15	Applied to Cordio Output
0070h	Angle linearization table, value -16	Applied to Cordic Output
0071h	Angle linearization table, value -15	
•••		
007Eh	Angle linearization table, value -2	
007Fh	Angle linearization table, value -1	



9 Magnet features

9.1 Magnet Range Extension

If the magnet is far away from the sensor, the field vectors in the sensor position can generate false angle information. By exploiting the magnetic field behaviour it is still possible to calculate correct position information. As absolute field values are used during this calculation external disturbance fields must not exceed a maximum of approximately ten times the terrestrial magnetic field. The position range extending calculation method can be disabled if large disturbance fields occur during operation.

MgRangExt = 0: angles between -180° and +180° can b e measured MgRangExt = 1: angles between -288° and +288° can b e measured

Register	Access	Bit	Function	Note
		D11	Mgrangex	"Magnet Range Extension" Enable the algorithm for an extended position range.
000Bh: Sequencer control	R/W	D10	CoordSel	"Coordinate System Selection" 1 = The sign of the LinAng (Register 0122h) gets changed if MagDir (Register 000Bh) = 1 0 = LinAng (Register 0122h) gets not changed

Notes:

- Pins LOCK_N and SCE are test pins for factory testing. They must be connected to VSS in normal operation to prevent accidental enabling of a test mode
- 3) Output READY is set high when a measurement cycle is completed and the results in the output registers are valid. It is cleared by reading data from address 0100h or 0122h
- 4) CLK allows monitoring of the internal clock or applying an external clock.
- 5) Output MISO is only activated when CS_N is low. It is in high impedance state otherwise, this allows parallel operation of multiple ICs.
- 6) CS_N is active low and activates data transmission. If only a single device is used, CS_N may remain low for several commands, for example while reading the output registers.



10 PWM data transmission

In addition to the SPI interface, the AS5410 offers a PWM output that provides data transmission of the linearized output data over a single wire. The base frequency of the PWM is the system clock frequency, so one PWM digit always corresponds to approx. 125ns. The PWM resolution is set by 3 bits (PWMPreScale) which shift the 16 bit wide angle value by 0 to 7 digits.

The duty cycle of the PWM signal lies between 0....100%. In case of an error, the duty cycle is 0%. If Register 0122h value increases the duty cycle decreases. If Register 0122h value decreases the duty cycle increases.

Register	Access	Bit	Function	Note
		D15-10	PWMLimitHi	PWM Limit High
		טוס-וט	<5:0>	Limits the PWM duty cycle to a maximum value
000Dh:		D0 4	PWMLimitLo	PWM Limit Low
PWM	R/W	/W D9-4	<5:0>	Limits the PWM duty cycle to a minimum value
settings		D3	PWMEn	PWM Enable, Enables the PWM output
		D2-0	PWMPreScale	PWM PreScale, Sets PWM frequency and resolution
		D2-0	<2:0>	

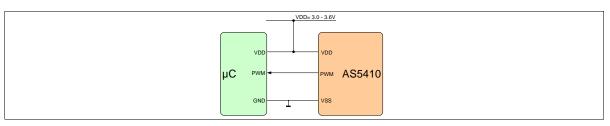


Figure 9: Single pin data transmission connection diagram

PWM Duty Cycle	Register 122h (Linear Angle)
[%]	[LSB]
0	32767
50	0
100	-32768

Between 0%...100% the duty cycle is linear to the Linear Angle.

PWM Enable: Must be set high to enable the PWM mode.

PWMPreScale0 PWMPreScale3	Resolutio n (bit)	PWM (kHz)
000	16	0.122
001	15	0.244
010	14	0.488
011	13	0.977
100	12	1.953
101	11	3.906
110	10	7.813
111	9	15.63



PWMLimitHi5...PWMLimitHi0: Limits the PWM duty cycle.

duty cycle	PWMLimitHi0PWMLimitHi5
minimum 50%	000000
minimum 0%	111111

Between 0%...50% the duty cycle limit is linear to the binary values selected by PWMLimitHi5...PWMLimitHi0. The limits are clamping limits (by selecting limits the resolution decreases).

PWMLimitLo5...PWMLimitLo0: Limits the PWM duty cycle.

duty cycle	PWMLimitLo0PWMLimitLo5
maximum 50%	111111
maximum 100%	000000

Between 50%...100% the duty cycle limit is linear to the binary values selected by PWMLimitLo5...PWMLimitLo0. The limits are clamping limits (by selecting limits the resolution decreases).

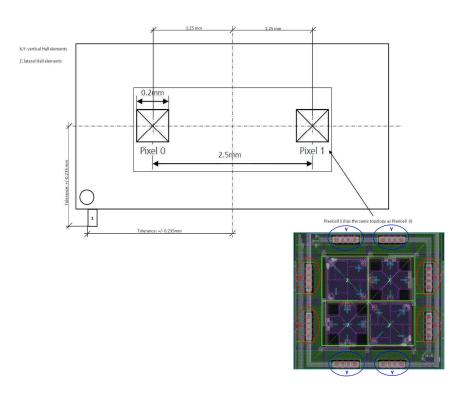
Example Table:

clamping range	0% – 100% PWM duty cycle	10% – 90% PWM duty cycle	50% – 50% PWM duty cycle
PWMLimitHi5	1	1	0
PWMLimitHi4	1	1	0
PWMLimitHi3	1	0	0
PWMLimitHi2	1	0	0
PWMLimitHi1	1	1	0
PWMLimitHi0	1	0	0
PWMLimitLo5	0	0	1
PWMLimitLo4	0	0	1
PWMLimitLo3	0	1	1
PWMLimitLo2	0	1	1
PWMLimitLo1	0	0	1
PWMLimitLo0	0	1	1



Package Drawings and Markings

10.1 Pixel cell placement





10.2 14-Lead Thin Shrink Small Outline Package TSSOP-14

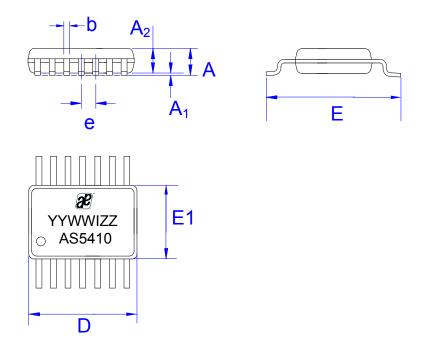


Figure 11: TSSOP-14 Package Dimensions and Marking

Dimensions							
Complete mm		inch					
Symbol	Min	Тур	Max	Min	Тур	Max	
Α			1.2			.047	
A1	0.05	0.10	0.15	.002	.004	.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
D	4.9	5	5.1	0.193	0.197	0.201	
E	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.169	0.173	0.176	
е		0.65		.0256			

Table 6: Package Dimensions

Marking: YYWWIZZ

YY: Last Digit of Manufacturing Year

WW: Manufacturing Week

I: Plant Identifier

ZZ: Traceability Code

Thermal Resistance $R_{th(j-a)}$: 89 K/W in still air, soldered on PCB

IC's marked with a white dot or the letters "ES" denote Engineering Samples



Ordering Information

The devices are available as standard products, shown in Table 7.

Model	Description	Delivery Form	Package
AS5410TSU	Three-Dimensional Hall Encoder	Tubes	TSSOP 14
AS5410TST		Tape & Reel	TSSOP 14

Table 7: Ordering Information

10.3 Revision History

Revision	Description	Change date
1.0	Released preliminary version	May.30.2011
1.1	Additional information added	Jun.05.2011
1.2	Additional information added	Jan.12.2012
1.5	Chapter 10: example table corrected	Apr.06.2012

Table 8: revision history



11 Copyrights

Copyright © 2011, austriamicrosystems AG, Schloss Premstaetten, 8141 Unterpremstaetten, Austria – Europe. Trademarks Registered ®. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

All products and companies mentioned are trademarks or registered trademarks of their respective companies.

12 Disclaimer

Devices sold by austriamicrosystems AG are covered by the warranty and patent indemnification provisions appearing in its Term of Sale. austriamicrosystems AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein or regarding the freedom of the described devices from patent infringement. austriamicrosystems AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with austriamicrosystems AG for current information. This product is intended for use in normal commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or lifesustaining equipment are specifically not recommended without additional processing by austriamicrosystems AG for each application.

The information furnished here by austriamicrosystems AG is believed to be correct and accurate. However, austriamicrosystems AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of austriamicrosystems AG rendering of technical or other services.



Contact Information

Headquarters

austriamicrosystems AG A-8141 Schloss Premstaetten, Austria

Tel: +43 (0) 3136 500 0 Fax: +43 (0) 3136 525 01

For Sales Offices, Distributors and Representatives, please visit:

http://www.austriamicrosystems.com/contact